CONUFL001-SMD-T - ACTIVE

TE Internal #: CONUFL001-SMD-T UMCC GEN 1 RF Interface, Jack, 50 ohm, Snap-On, 6 GHz Operating Frequency, 1 Position, Printed Circuit Board, Board Mount, -40 – 90 °C [-40 – 194 °F]

View on TE.com >



Connectors > RF Connectors > Coax Connectors



RF Interface: UMCC GEN 1

RF Connector Style: Jack

Impedance: 50Ω

RF Connector Coupling Mechanism: Snap-On

Operating Frequency: 6 GHz

Features

Product Type Features

Connector Product Type	Connector Assembly
RF Interface	UMCC GEN 1
RF Connector Style	Jack

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
PCB Mount Orientation	Vertical
Number of Positions	1
Number of Coaxial Contacts	1
Electrical Characteristics	
Impedance	50 Ω
Body Features	
Cable Connector Orientation	Straight
Body Material	Brass
Body Material Finish	Plated
Body Plating Material	Gold
Contact Features	
RF Connector Center Contact Plating Material	Gold

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RF Connector Center Contact Material	Brass
Termination Features	
Termination Method to PCB	Surface Mount
Termination Method to Wire & Cable	Solder
Mechanical Attachment	
RF Connector Coupling Mechanism	Snap-On
Connector Mounting Type	Board Mount
RF Contact Captivation Method	Mechanical
Detent	Without
Usage Conditions	
Operating Temperature Range	-40 - 90 °C[-40 - 194 °F]
Operation/Application	
Circuit Application	Signal
Operating Frequency	6 GHz
Packaging Features	
Packaging Quantity	2500
Packaging Method	Tape & Reel



Other

Dielectric Material	Liquid Crystal Polymer
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant with Exempt
EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Abo
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidat (241) Candidate List Declared (240) SVHC > Threshold: Pb (4.35% in Componen Article Safe Usage Statements: Do not eat, drink or smoke when using this pr handling. Recycle if possible and dispose of th governmental regulations relevant to your ge
Halogen Content	Low Halogen - Br, Cl, F,

Exemptions

erials Above Threshold

Candidate List: JUNE 2024 Declared Against: JAN 2024

mponent Part)

nen using this product. Wash thoroughly after nd dispose of the article by following all applicable vant to your geographic location.

Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC

C For support call+1 800 522 6752

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Free

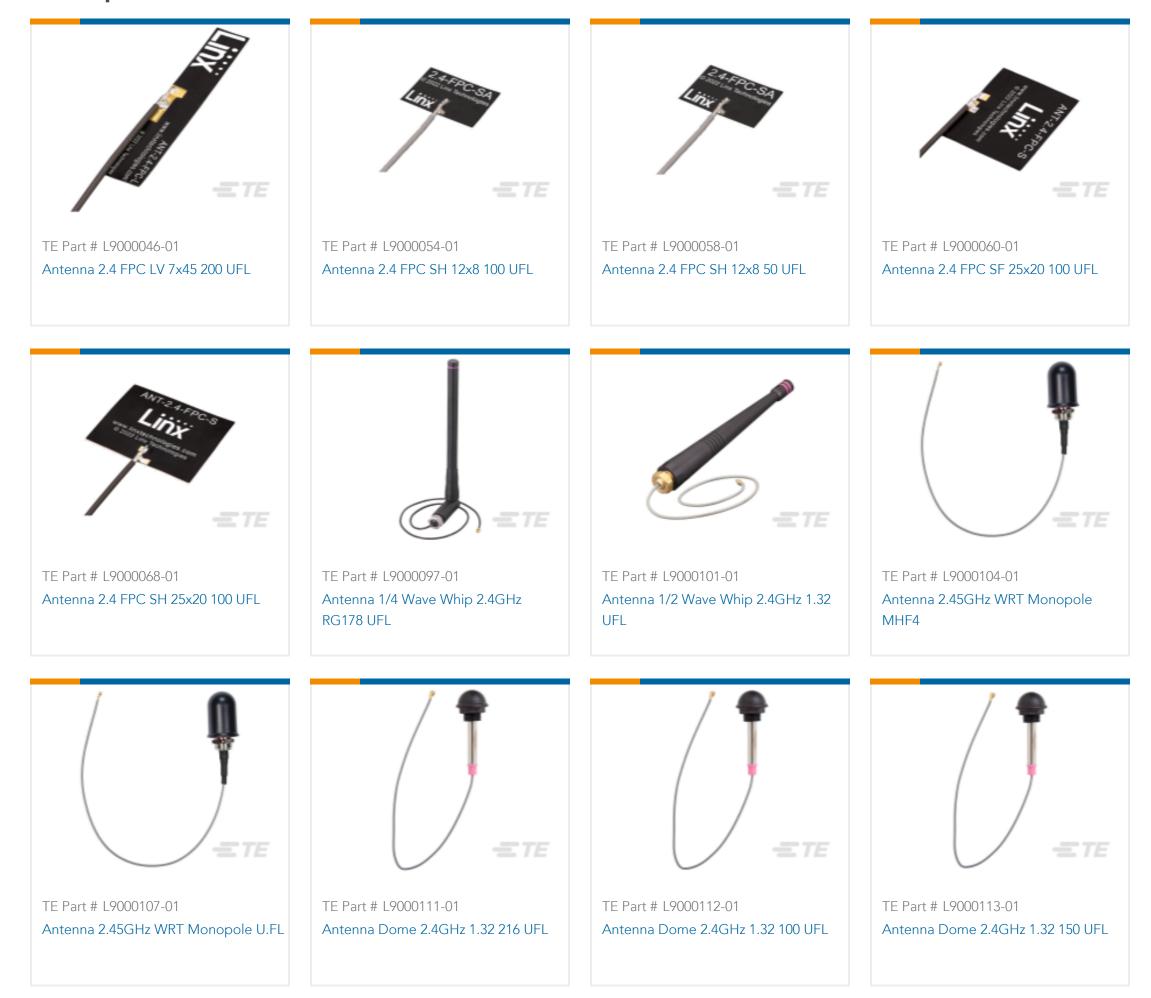
Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

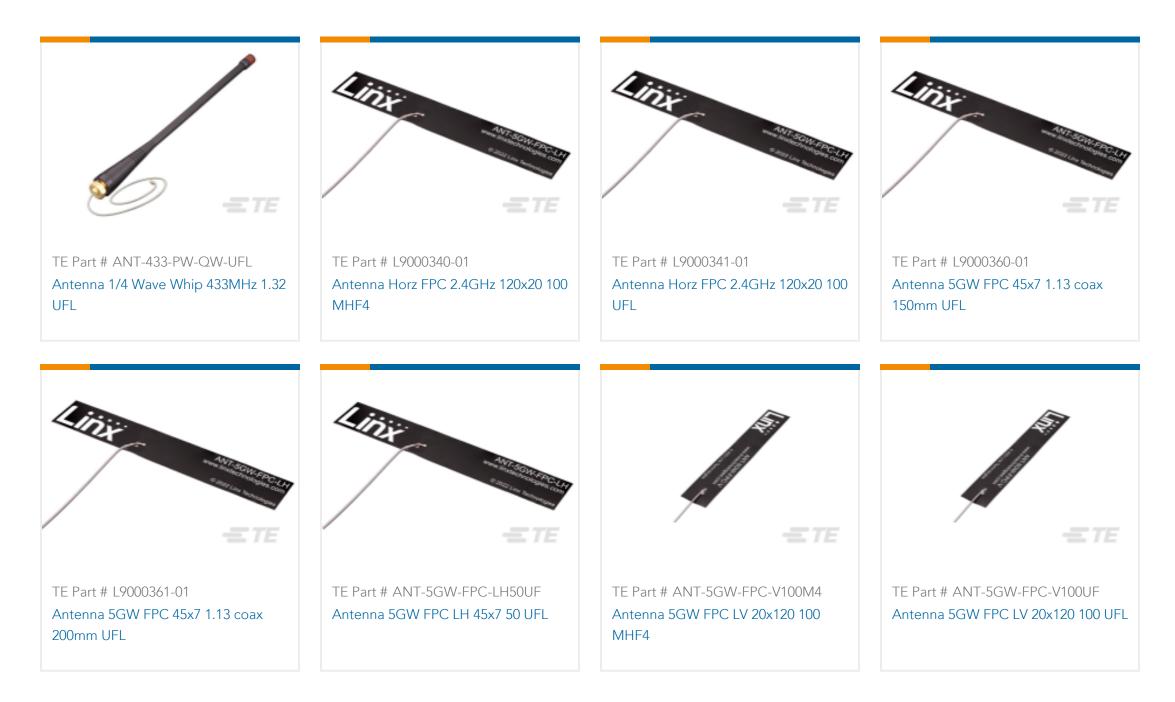
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts

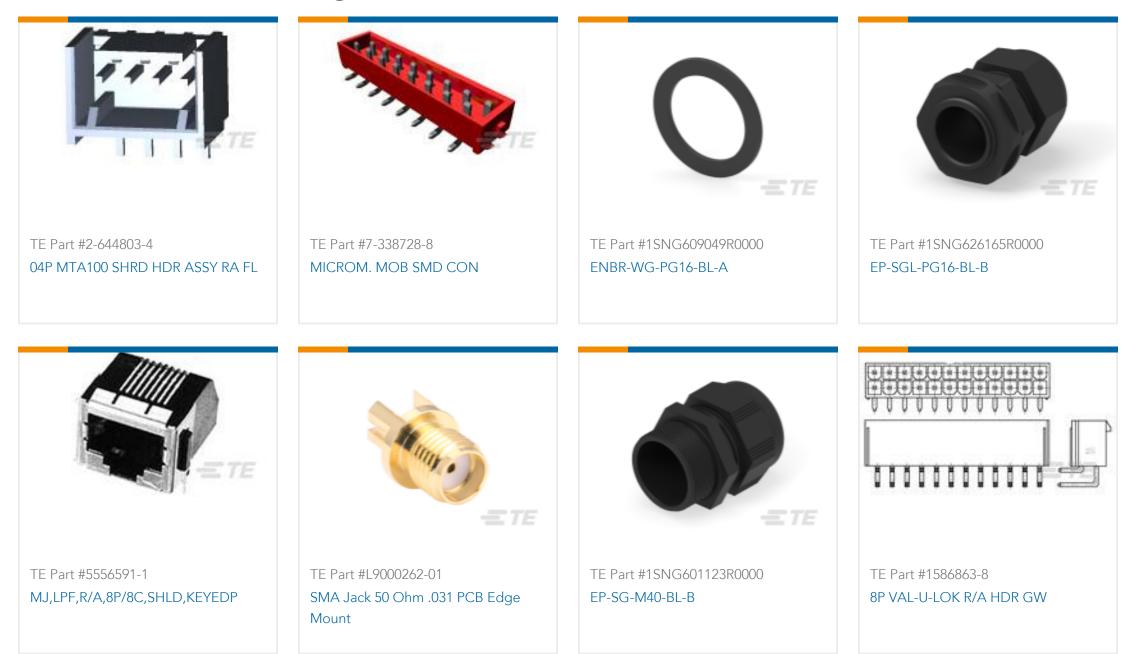


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Customers Also Bought





Documents

UMCC GEN 1 RF Interface, Jack, 50 ohm, Snap-On, 6 GHz Operating Frequency, 1 Position, Printed Circuit Board, Board Mount, -40 – 90 °C [-40 – 194 °F]



CAD Files Customer View Model ENG_CVM_CVM_CONUFL001-SMD-T_B.3d_igs.zip English 3D PDF 3D Customer View Model ENG_CVM_CVM_CONUFL001-SMD-T_B.2d_dxf.zip English Customer View Model ENG_CVM_CVM_CONUFL001-SMD-T_B.3d_stp.zip English

Datasheets & Catalog Pages MICRO COAXIAL SURFACE MOUNT CONNECTOR

English